PD - 94964

International

IRL640PbF

HEXFET[®] Power MOSFET

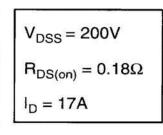
- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- RDS(on) Specified at VGS=4V & 5V
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements

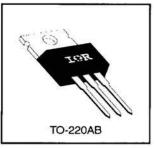


Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.





Absolute Maximum Ratings

	Parameter	Max.	Units	
I _D @ T _C = 25°C	Continuous Drain Current, VGS @ 5.0 V	17		
I _D @ T _C = 100°C	Continuous Drain Current, VGS @ 5.0 V	11	A	
IDM	Pulsed Drain Current ①	68		
P _D @ T _C = 25°C	Power Dissipation	125	W	
	Linear Derating Factor	1.0	W/°C	
Vgs	Gate-to-Source Voltage	±10	V	
Eas	Single Pulse Avalanche Energy ②	580	mJ	
IAR	Avalanche Current ①	10	А	
EAR	Repetitive Avalanche Energy ①	13	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns	
TJ TSTG	Operating Junction and Storage Temperature Range	-55 to +150	°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)	1	

Thermal Resistance

ware we	Parameter	Min.	Тур.	Max.	Units
RNC	Junction-to-Case			1.0	
Recs	Case-to-Sink, Flat, Greased Surface		0.50		_ ∘c/M
Reja	Junction-to-Ambient	_		62	

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	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	200	_	-	V	V _{GS} =0V, I _D = 250µA	
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	- 1	0.27		V/°C	Reference to 25°C, ID= 1mA	
R _{DS(on)}	Static Drain-to-Source On-Resistance	_	-	0.18	0	VGS=5.0V, ID=10A @	
HDS(on)		-	-	0.27	Ω	VGS=4.0V, ID=8.5A @	
VGS(th)	Gate Threshold Voltage	1.0	_	2.0	V	VDS=VGS, ID= 250µA	
9ts	Forward Transconductance	16	-	—	S	VDS=50V, ID=10A @	
IDSS	Drain-to-Source Leakage Current	-	-	25		V _{DS} =200V, V _{GS} =0V	
1055		-	_	250	μA	VDS=160V, VGS=0V, TJ=125°C	
Igss	Gate-to-Source Forward Leakage		-	100	nA	V _{GS} =10V	
1655	Gate-to-Source Reverse Leakage	-		-100		V _{GS} =-10V	
Qg	Total Gate Charge	-	-	66		ID=17A	
Q _{gs}	Gate-to-Source Charge	-	—	9.0	nC	V _{DS} =160V	
Q _{gd}	Gate-to-Drain ("Miller") Charge	-	_	38		V _{GS} =5.0V See Fig. 6 and 13	
td(on)	Turn-On Delay Time	—	8.0	-		V _{DD} =100V	
tr	Rise Time		83		ns	ID=17A	
td(off)	Turn-Off Delay Time		44		1 115	$\begin{array}{l} R_{G}{=}4.6\Omega\\ R_{D}{=}5.7\Omega \text{See Figure 10} @ \end{array}$	
tr	Fall Time	-	52	<u></u>	1		
Lo	Internal Drain Inductance	-	4.5	8 -0	للما	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance	_	7.5	(1000	nH	from package and center of die contact	
Ciss	Input Capacitance	-	1800	8-8	I	V _{GS} =0V	
Coss	Output Capacitance		400	l s ren	pF	V _{DS} = 25V	
Crss	Reverse Transfer Capacitance	-	120			f=1.0MHz See Figure 5	

Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
ls	Continuous Source Current (Body Diode)	_		17		MOSFET symbol showing the	
ISM	Pulsed Source Current (Body Diode) (1)			68	A	p-n junction diode.	
VSD	Diode Forward Voltage		· · · ·	2.0	V	TJ=25°C, IS=17A, VGS=0V @	
trr	Reverse Recovery Time		310	470	ns	T_J=25°C, IF=17A	
Qrr	Reverse Recovery Charge	-	3.2	4.8	μC	_ di/dt=100A/µs ④	
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+Lp)					

Notes:

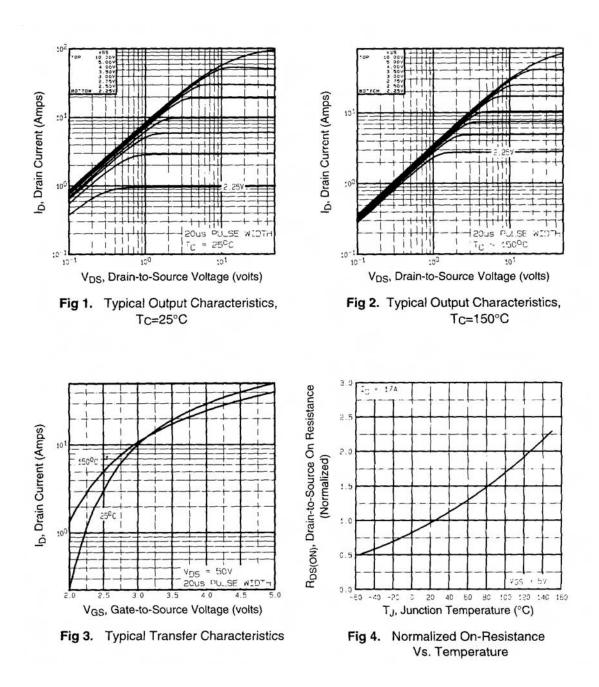
- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ IsD≤17A, di/dt≤150A/µs, VDD≤V(BR)DSS, TJ≤150°C
- ② VDD=50V, starting TJ=25°C, L=3.0mH RG=25Ω, IAS=17A (See Figure 12)

④ Pulse width \leq 300 µs; duty cycle \leq 2%.

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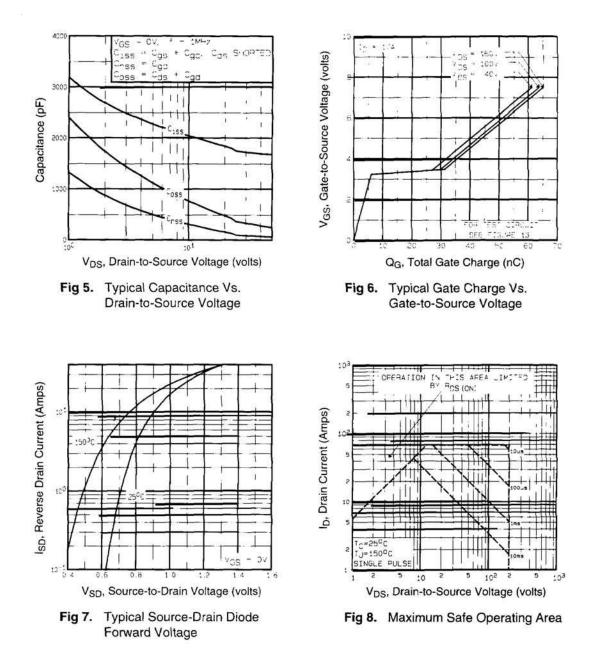


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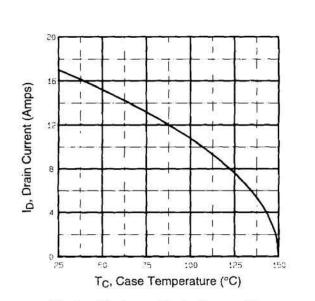
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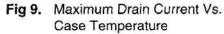
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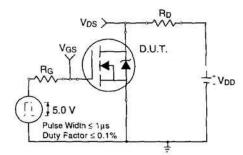


Fig 10a. Switching Time Test Circuit

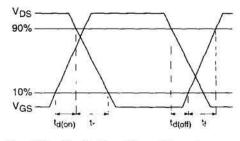


Fig 10b. Switching Time Waveforms

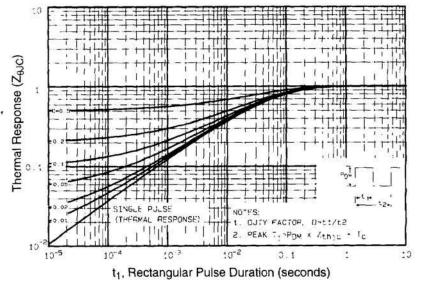
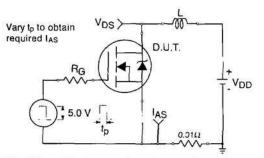
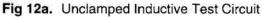


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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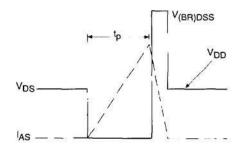


Fig 12b. Unclamped Inductive Waveforms

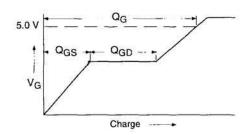


Fig 13a. Basic Gate Charge Waveform

Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit Appendix B: Package Outline Mechanical Drawing

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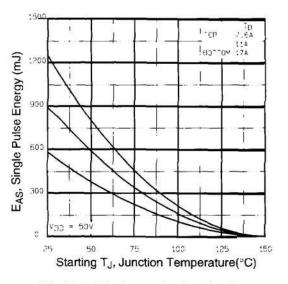


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

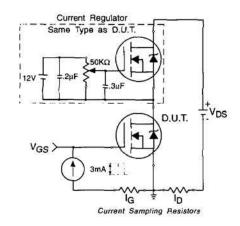
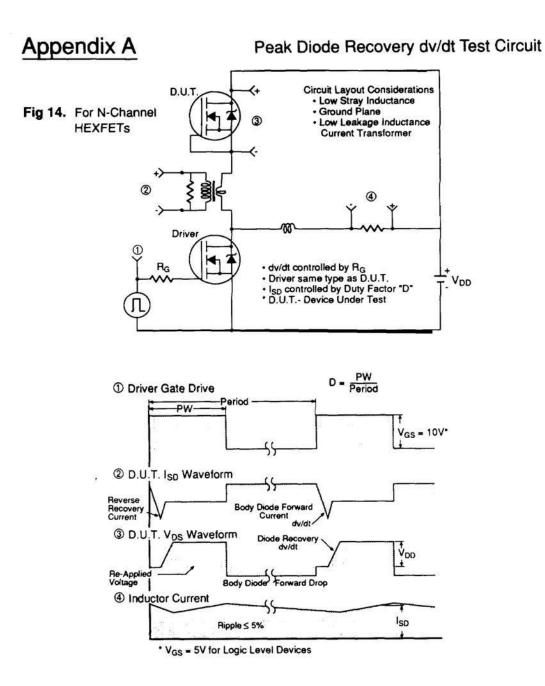


Fig 13b. Gate Charge Test Circuit

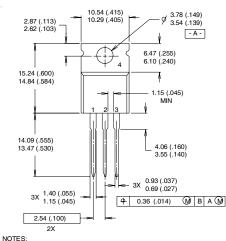


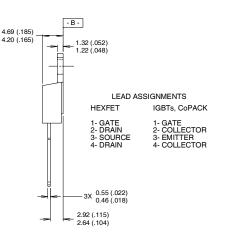
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TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



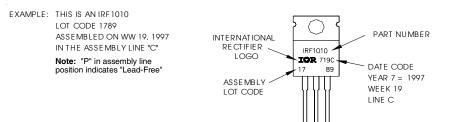


3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB. 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information

1 DIMENSIONING & TOLEBANCING PER ANSI Y14.5M, 1982.

2 CONTROLLING DIMENSION : INCH



Data and specifications subject to change without notice.

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